

(1,27 mm) .050"

RSM SERIES

T MICRO SOCKET

SPECIFICATIONS For complete specifications and recommended PCB layouts see www.samtec.com?RSM Insulator Material: Black Liquid Crystal Polymer Contact Material: Phosphor Bronze Plating: Au or Śn over 50μ" (1,27 μm) Ni Current Rating (RSM/FTR):

3.1 A per pin (1 pin powered per row)
Operating Temp Range:
-55°C to +125°C
Contact Resistance:

10 m Ω **Lead Size Accepted:** (0,46 mm) .018" SQ Insertion Depth:

Top Entry = (2,64 mm) .104" to (5,84 mm) .230" with (0,38 mm) .015" wipe, or pass-through. Bottom Entry = (5,49 mm) .216" minimum (Add board thickness for correct post OAL) Insertion Force: (Single contact only)

5 oz (0,97 N) avg. Withdrawal Force: (Single contact only) 1.5 oz (0,42 N) avg. RoHS Compliant: Yes

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0,10 mm) .004" max

RECOGNITIONS

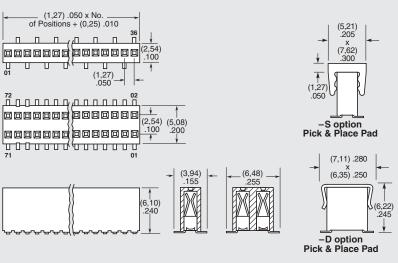
For complete scope of recognitions see www.samtec.com/quality

options are non-standard, non-returnable.





Optional Pick & Place Mates with: Pad FTR, HTMS, HDWM, DWM, TML, ZML, TMS **OPTIONS** (6,10 mm) -P OPTION .240" Optional -TR OPTION Tape & Reel packaging **ALSO AVAILABLE** (MOQ Required) (1,27 mm) Surface Mount .050" · Other platings Locking clips Contact Samtec. NO. PINS **PLATING ROW** $\overline{\mathsf{RSM}}$ **OPTION OPTION PER ROW OPTION** -S –K = 10µ" (0,25 µm) = Single = (6,25 mm) .246" DIA 02 thru 36 Gold on contact, Row Matte Tin on tail –D Pick & = Double Place Pad (5 positions Row minimum for -D) (7 positions minimum (1.27) .050 x No for -S) of Positions + (0,25) .010 (5,21) .205 ДΩ п -P пп (7,62) = Plastic П П Pick & Place Pad



Polyimide film (-D = 5)

> -S = 6positions minimum) -TR = Tape &

Reel

positions

minimum